IGBT - Field Stop, Trench

700 V, 40 A

FGH40T70SHD

Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 3rd generation IGBTs offer the optimum performance for Solar Inverter, UPS, Welder, Telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature : T_J =175°C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} =1.7 V(Typ.) @ I_C = 40 A
- 100% of the Parts Tested for $I_{LM}(1)$
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- These Devices are Pb-Free and are RoHS Compliant

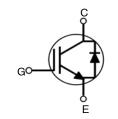
Applications

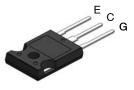
• Solar Inverter, UPS, Welder, Telecom, ESS, PFC



ON Semiconductor®

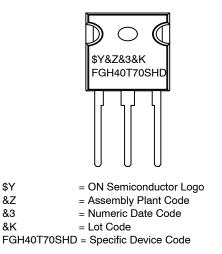
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TO-247-3LD CASE 340CH

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

Desc	Symbol	Rating	Unit	
Collector to Emitter Voltage		V _{CES}	700	V
Gate to Emitter Voltage		V _{GES}	±20	V
Transient Gate to Emitter Voltage		±30	V	
Collector Current	$T_{C} = 25^{\circ}C$	Ι _C	80	А
Collector Current	$T_{\rm C} = 100^{\circ}{\rm C}$		40	А
Pulsed Collector Current	$T_{C} = 25^{\circ}C$	I _{LM} (Note 1)	120	А
Pulsed Collector Current		I _{CM} (Note 2)	120	А
Diode Forward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	١ _F	40	А
Diode Forward Current	T _C = 100°C		20	А
Pulsed Diode Maximum Forward Current		I _{FM} (Note 2)	120	А
Maximum Power Dissipation	um Power Dissipation $T_{C} = 25^{\circ}C$		268	W
Maximum Power Dissipation	T _C = 100°C	1 [134	W
Operating Junction Temperature	TJ	-55 to +175	°C	
Storage Temperature Range	T _{stg}	-55 to +175	°C	
Maximum Lead Temp. for soldering Pur	ΤL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, I_C = 120 \text{ A}, R_G = 30 \Omega$, Inductive Load 2. Repetive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (IGBT)	-	0.56	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (Diode)	-	1.71	°C/W
Thermal Resistance, Junction to Ambient	R_{\thetaJA}	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH40T70SHD-F155	FGH40T70SHD	TO-247-3 (Pb-Free)	Tube	-	-	30

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I _C = 250 μ A	700	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES}/\Delta T_{J}$	I_{C} = 1 mA, Reference to 25°C	-	0.6	_	V/°C
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μΑ
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICs						
G-E Threshold Voltage	V _{GE(th)}	I_{C} = 40 mA, V_{CE} = V_{GE}	4.0	5.5	7.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 40 A, V _{GE} = 15 V	-	1.7	2.15	V
		I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 175°C	-	2.37	-	V

ELECTRICAL CHARACTERISTICS OF THE IGE	T ($T_C = 25^{\circ}C$ unless otherwise noted) (continued)
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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS				•		
Input Capacitance	C _{ies}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	2028	-	pF
Output Capacitance	C _{oes}	-	-	75	-	pF
Reverse Transfer Capacitance	C _{res}	-	-	26	-	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	-	22	-	ns
Rise Time	t _r	$R_G = 6 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	40	-	ns
Turn-Off Delay Time	t _{d(off)}		-	66	-	ns
Fall Time	t _f		-	10	-	ns
Turn-On Switching Loss	E _{on}		-	1150	-	μJ
Turn-Off Switching Loss	E _{off}		-	271	-	μJ
Total Switching Loss	E _{ts}		-	1421	-	μJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	-	20	-	ns
Rise Time	tr	$R_{G} = 6 \Omega, V_{GE} = 15 V,$ Inductive Load, $T_{C} = 175^{\circ}C$	-	36	-	ns
Turn-Off Delay Time	t _{d(off)}	-	-	68	-	ns
Fall Time	t _f	-	-	13	-	ns
Turn-On Switching Loss	E _{on}	-	-	1760	-	μJ
Turn-Off Switching Loss	E _{off}	-	_	455	-	μJ
Total Switching Loss	E _{ts}		_	2215	-	μJ
Total Gate Charge	Qg	V_{CE} = 400 V, I_{C} = 40 A, V_{GE} = 15 V	_	69	-	nC
Gate to Emitter Charge	Q _{ge}	7	-	13	-	nC
Gate to Collector Charge	Q _{gc}	7	_	26	_	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_J = 25° C unless otherwise noted)

Parametr	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	I _F = 20 A	T _C = 25°C	-	2.0	2.5	V
			T _C = 175°C	-	1.73	-	
Reverse Recovery Energy	E _{rec}	$I_F = 20 \text{ A}, \text{ d}I_F / \text{ d}t = 200 \text{ A}/\mu\text{s}$	T _C = 175°C	-	54	-	μJ
Diode Reverse Recovery Time	t _{rr}		T _C = 25°C	-	37	-	ns
			T _C = 175°C	-	235	-	
Diode Reverse Recovery Charge	Q _{rr}		T _C = 25°C	-	65	-	nC
			T _C = 175°C	_	944	_	

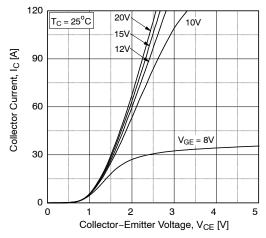


Figure 1. Typical Output Characteristics

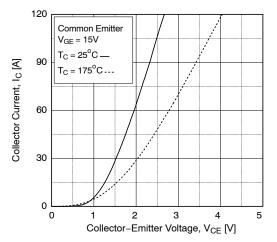


Figure 3. Typical Saturation Voltage Characteristics

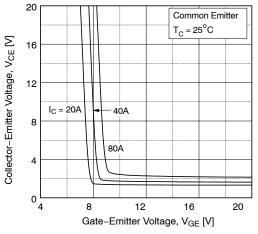


Figure 5. Saturation Voltage vs V_{GE}

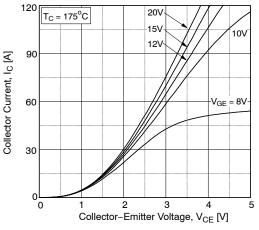


Figure 2. Typical Output Characteristics

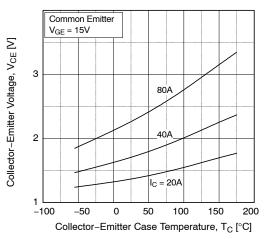
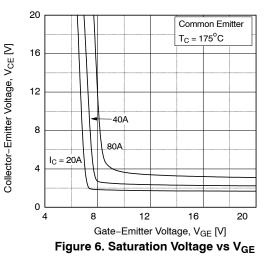
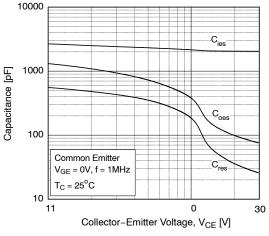


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level







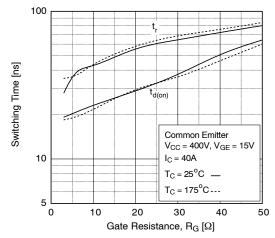
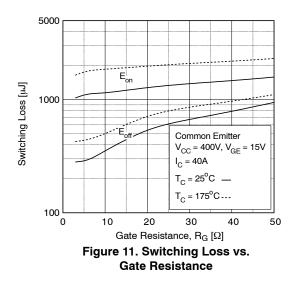


Figure 9. Turn-On Characteristics vs. Gate Resistance



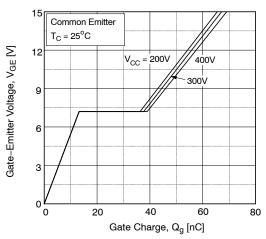


Figure 8. Gate Charge Characteristic

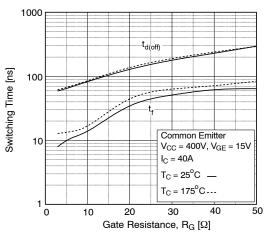
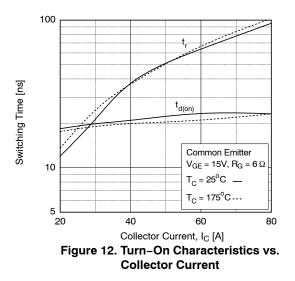
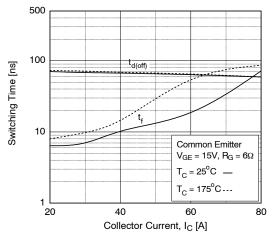


Figure 10. Turn–Off Characteristics vs. Gate Resistance







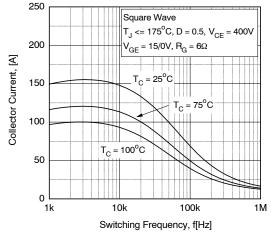
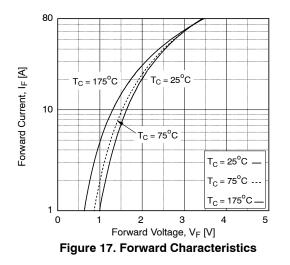
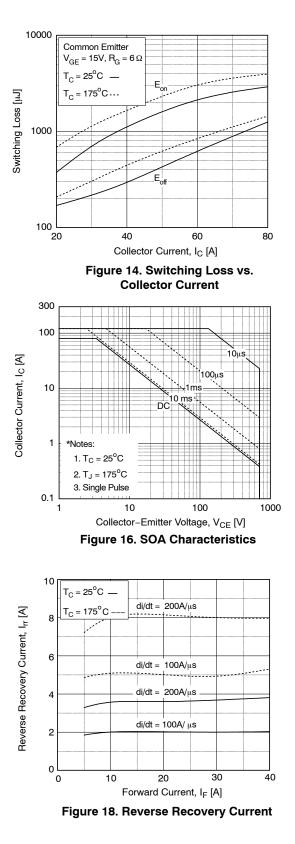
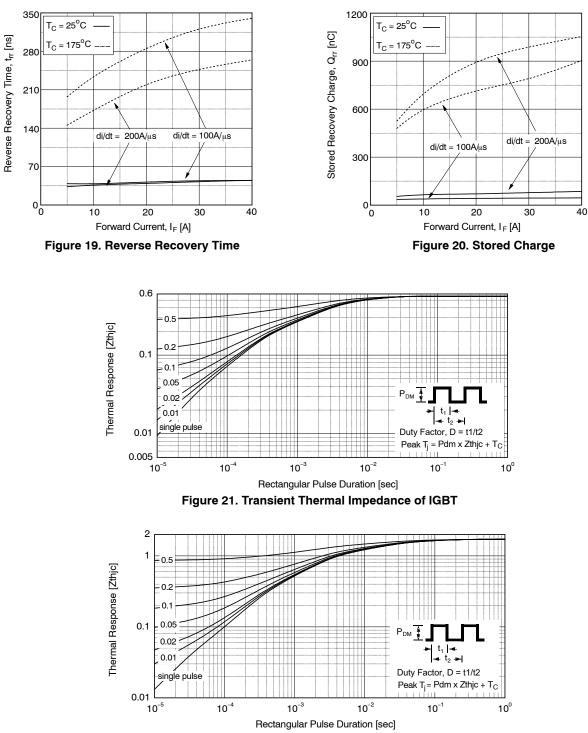


Figure 15. Load Current vs. Frequency





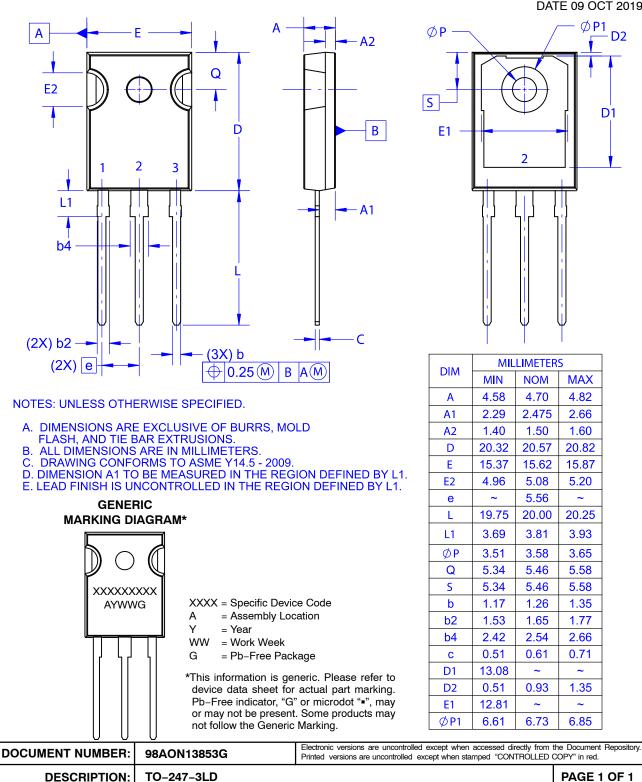






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